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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	40 MIPs
Connectivity	CANbus, I <sup>2</sup> C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	53
Program Memory Size	128KB (43K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 18x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-VFQFN Exposed Pad
Supplier Device Package	64-VQFN (9x9)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24hj128gp506a-i-mr

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

#### 2.5 ICSP Pins

The PGECx and PGEDx pins are used for In-Circuit Serial Programming™ (ICSP™) and debugging purposes. It is recommended to keep the trace length between the ICSP connector and the ICSP pins on the device as short as possible. If the ICSP connector is expected to experience an ESD event, a series resistor is recommended, with the value in the range of a few tens of Ohms, not to exceed 100 Ohms.

Pull-up resistors, series diodes, and capacitors on the PGECx and PGEDx pins are not recommended as they will interfere with the programmer/debugger communications to the device. If such discrete components are an application requirement, they should be removed from the circuit during programming and debugging. Alternatively, refer to the AC/DC characteristics and timing requirements information in the "dsPIC33F/PIC24H Flash Programming Specification" (DS70152) for information on capacitive loading limits and pin input voltage high (VIH) and input low (VIL) requirements.

Ensure that the "Communication Channel Select" (i.e., PGECx/PGEDx pins) programmed into the device matches the physical connections for the ICSP to MPLAB® ICD 3 or MPLAB REAL ICE $^{\rm TM}$ .

For more information on ICD 3 and REAL ICE connection requirements, refer to the following documents that are available on the Microchip web site.

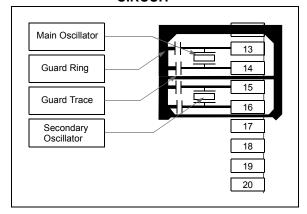
- "Using MPLAB® ICD 3 In-Circuit Debugger" (poster) DS51765
- "MPLAB® ICD 3 Design Advisory" DS51764
- "MPLAB<sup>®</sup> REAL ICE™ In-Circuit Emulator User's Guide" DS51616
- "Using MPLAB® REAL ICE™" (poster) DS51749

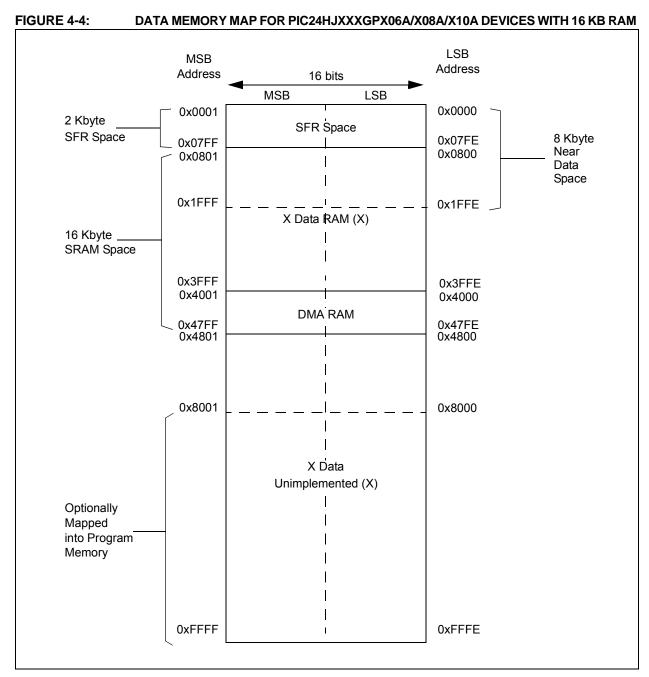
#### 2.6 External Oscillator Pins

Many MCUs have options for at least two oscillators: a high-frequency primary oscillator and a low-frequency secondary oscillator (refer to **Section 9.0 "Oscillator Configuration"** for details).

The oscillator circuit should be placed on the same side of the board as the device. Also, place the oscillator circuit close to the respective oscillator pins, not exceeding one-half inch (12 mm) distance between them. The load capacitors should be placed next to the oscillator itself, on the same side of the board. Use a grounded copper pour around the oscillator circuit to isolate them from surrounding circuits. The grounded copper pour should be routed directly to the MCU ground. Do not run any signal traces or power traces inside the ground pour. Also, if using a two-sided board, avoid any traces on the other side of the board where the crystal is placed. A suggested layout is shown in Figure 2-3.

FIGURE 2-3: SUGGESTED PLACEMENT
OF THE OSCILLATOR
CIRCUIT





### 4.2.5 DMA RAM

Every PIC24HJXXXGPX06A/X08A/X10A device contains 2 Kbytes of dual ported DMA RAM located at the end of data space. Memory locations in the DMA RAM space are accessible simultaneously by the CPU and the DMA controller module. DMA RAM is utilized by the DMA controller to store data to be transferred to various peripherals using DMA, as well as data

transferred from various peripherals using DMA. The DMA RAM can be accessed by the DMA controller without having to steal cycles from the CPU.

When the CPU and the DMA controller attempt to concurrently write to the same DMA RAM location, the hardware ensures that the CPU is given precedence in accessing the DMA RAM location. Therefore, the DMA RAM provides a reliable means of transferring DMA data without ever having to stall the CPU.

Note: DMA RAM can be used for general purpose data storage if the DMA function is not required in an application.

		1										1	1					1
File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
C2RXF11EID	056E				EID<	:15:8>				EID<7:0>								xxxx
C2RXF12SID	0570				SID<	:10:3>				SID<2:0> — EXIDE — EID<17:16>				7:16>	xxxx			
C2RXF12EID	0572				EID<	:15:8>				EID<7:0>					xxxx			
C2RXF13SID	0574	SID<10:3>					SID<2:0>		_	EXIDE	_	EID<1	7:16>	xxxx				
C2RXF13EID	0576				EID<	:15:8>							EID<7	':0>				xxxx
C2RXF14SID	0578				SID<	:10:3>					SID<2:0>		_	EXIDE	_	EID<1	7:16>	xxxx
C2RXF14EID	057A				EID<	:15:8>				EID<7:0>							xxxx	
C2RXF15SID	057C				SID<	:10:3>					SID<2:0>		_	EXIDE	_	EID<1	7:16>	xxxx
C2RXF15EID	057E				EID<	:15:8>				EID<7:0>					xxxx			

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal for PinHigh devices.

#### REGISTER 7-11: IEC1: INTERRUPT ENABLE CONTROL REGISTER 1

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
U2TXIE	U2RXIE	INT2IE	T5IE	T4IE	OC4IE	OC3IE	DMA2IE
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
IC8IE	IC7IE	AD2IE	INT1IE	CNIE	_	MI2C1IE	SI2C1IE
bit 7							bit 0

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∟Եց	CI	ıu	•

bit 14

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 **U2TXIE:** UART2 Transmitter Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

U2RXIE: UART2 Receiver Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 13 INT2IE: External Interrupt 2 Enable bit

1 = Interrupt request enabled 0 = Interrupt request not enabled

bit 12 **T5IE:** Timer5 Interrupt Enable bit

1 = Interrupt request enabled

0 = Interrupt request not enabled

bit 11 T4IE: Timer4 Interrupt Enable bit

1 = Interrupt request enabled

0 = Interrupt request not enabled

bit 10 OC4IE: Output Compare Channel 4 Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 9 OC3IE: Output Compare Channel 3 Interrupt Enable bit

1 = Interrupt request enabled

0 = Interrupt request not enabled

bit 8 DMA2IE: DMA Channel 2 Data Transfer Complete Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 7 IC8IE: Input Capture Channel 8 Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 6 IC7IE: Input Capture Channel 7 Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 5 AD2IE: ADC2 Conversion Complete Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 4 **INT1IE:** External Interrupt 1 Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

#### REGISTER 7-21: IPC6: INTERRUPT PRIORITY CONTROL REGISTER 6

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
_		T4IP<2:0>		_		OC4IP<2:0>	
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
_		OC3IP<2:0>		_		DMA2IP<2:0>	
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 **T4IP<2:0>:** Timer4 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as '0'

bit 10-8 OC4IP<2:0>: Output Compare Channel 4 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

.

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 7 **Unimplemented:** Read as '0'

bit 6-4 OC3IP<2:0>: Output Compare Channel 3 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

•

•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as '0'

bit 2-0 DMA2IP<2:0>: DMA Channel 2 Data Transfer Complete Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

•

•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

### REGISTER 9-4: OSCTUN: FRC OSCILLATOR TUNING REGISTER(2)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_			TUN<	<5:0> <sup>(1)</sup>		
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

```
bit 15-6

Unimplemented: Read as '0'

TUN<5:0>: FRC Oscillator Tuning bits(1)

111111 = Center frequency - 0.375% (7.345 MHz)

.

100001 = Center frequency - 11.625% (6.52 MHz)

100000 = Center frequency - 12% (6.49 MHz)

011111 = Center frequency + 11.625% (8.23 MHz)

011110 = Center frequency + 11.25% (8.20 MHz)

.

000001 = Center frequency + 0.375% (7.40 MHz)

000000 = Center frequency (7.37 MHz nominal)
```

- **Note 1:** OSCTUN functionality has been provided to help customers compensate for temperature effects on the FRC frequency over a wide range of temperatures. The tuning step size is an approximation and is neither characterized nor tested.
  - 2: This register is reset only on a Power-on Reset (POR).

**FIGURE 13-2: TIMER2 (16-BIT) BLOCK DIAGRAM** TCKPS<1:0> TON 2 T2CK Prescaler 1, 8, 64, 256 Gate Sync 01 00 TGATE TCS TCY **TGATE** D Q Set T2IF ◀ Q √ск 0 Reset TMR2 Sync Comparator Equal PR2

### REGISTER 13-2: TyCON (T3CON, T5CON, T7CON OR T9CON) CONTROL REGISTER

R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
TON <sup>(1)</sup>	_	TSIDL <sup>(2)</sup>	_	_	_	_	_
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0	U-0
_	TGATE <sup>(1)</sup>	TCKPS<1:0>(1)		_	_	TCS <sup>(1,3)</sup>	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 **TON:** Timery On bit<sup>(1)</sup>

1 = Starts 16-bit Timery

0 = Stops 16-bit Timery

bit 14 Unimplemented: Read as '0'

bit 13 **TSIDL:** Stop in Idle Mode bit<sup>(2)</sup>

1 = Discontinue module operation when device enters Idle mode

0 = Continue module operation in Idle mode

bit 12-7 Unimplemented: Read as '0'

bit 6 **TGATE:** Timery Gated Time Accumulation Enable bit<sup>(1)</sup>

When TCS = 1: This bit is ignored. When TCS = 0:

1 = Gated time accumulation enabled0 = Gated time accumulation disabled

bit 5-4 TCKPS<1:0>: Timer3 Input Clock Prescale Select bits<sup>(1)</sup>

11 = 1:256 10 = 1:64

01 = 1:8 00 = 1:1

bit 3-2 **Unimplemented:** Read as '0'

bit 1 TCS: Timery Clock Source Select bit (1,3)

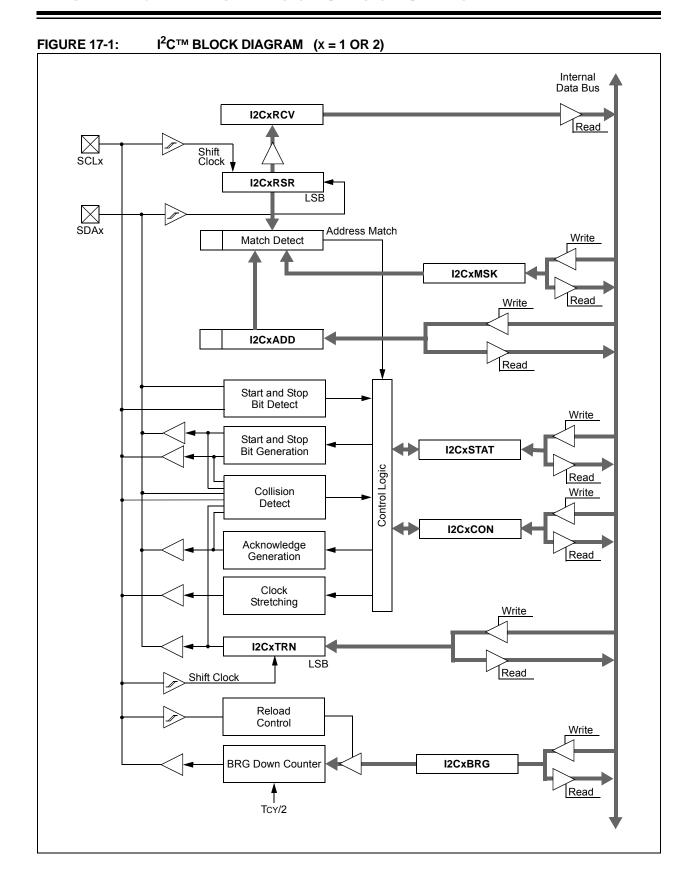
1 = External clock from pin TyCK (on the rising edge)

0 = Internal clock (FcY)

bit 0 **Unimplemented:** Read as '0'

**Note 1:** When 32-bit operation is enabled (T2CON<3> = 1), these bits have no effect on Timery operation; all timer functions are set through T2CON.

- 2: When 32-bit timer operation is enabled (T32 = 1) in the Timer Control register (TxCON<3>), the TSIDL bit must be cleared to operate the 32-bit timer in Idle mode.
- 3: The TyCK pin is not available on all timers. Refer to the "Pin Diagrams" section for the available pins.



### 18.3 UART Control Registers

### REGISTER 18-1: UXMODE: UARTX MODE REGISTER

R/W-0	U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
UARTEN <sup>(1)</sup>	_	USIDL	IREN <sup>(2)</sup>	RTSMD	_	UEN<1:0>	
bit 15							bit 8

R/W-0 HC	R/W-0	R/W-0 HC	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
WAKE	LPBACK	ABAUD	URXINV	BRGH	PDSEL	<1:0>	STSEL
bit 7							bit 0

Legend:HC = Hardware clearedR = Readable bitW = Writable bitU = Unimplemented bit, read as '0'-n = Value at POR'1' = Bit is set'0' = Bit is clearedx = Bit is unknown

bit 15 **UARTEN:** UARTx Enable bit<sup>(1)</sup>

1 = UARTx is enabled; all UARTx pins are controlled by UARTx as defined by UEN<1:0>

0 = UARTx is disabled; all UARTx pins are controlled by port latches; UARTx power consumption minimal

bit 14 Unimplemented: Read as '0'

bit 13 USIDL: Stop in Idle Mode bit

1 = Discontinue module operation when device enters Idle mode

0 = Continue module operation in Idle mode

bit 12 IREN: IrDA® Encoder and Decoder Enable bit(2)

1 = IrDA<sup>®</sup> encoder and decoder enabled 0 = IrDA<sup>®</sup> encoder and decoder disabled

bit 11 RTSMD: Mode Selection for UxRTS Pin bit

 $1 = \overline{\text{UxRTS}} \text{ pin in Simplex mode}$   $0 = \overline{\text{UxRTS}} \text{ pin in Flow Control mode}$ 

bit 10 **Unimplemented:** Read as '0' bit 9-8 **UEN<1:0>:** UARTx Enable bits

11 = UxTX, UxRX and BCLK pins are enabled and used; UxCTS pin controlled by port latches

10 = UxTX, UxRX,  $\overline{\text{UxCTS}}$  and  $\overline{\text{UxRTS}}$  pins are enabled and used

01 = UxTX, UxRX and UxRTS pins are enabled and used; UxCTS pin controlled by port latches

00 = UxTX and UxRX pins are enabled and used; UxCTS and UxRTS/BCLK pins controlled by port latches

bit 7 WAKE: Wake-up on Start bit Detect During Sleep Mode Enable bit

1 = UARTx will continue to sample the UxRX pin; interrupt generated on falling edge; bit cleared in hardware on following rising edge

0 = No wake-up enabled

bit 6 LPBACK: UARTx Loopback Mode Select bit

1 = Enable Loopback mode0 = Loopback mode is disabled

bit 5 ABAUD: Auto-Baud Enable bit

1 = Enable baud rate measurement on the next character – requires reception of a Sync field (0x55) before any data; cleared in hardware upon completion

0 = Baud rate measurement disabled or completed

**Note 1:** Refer to **Section 17. "UART"** (DS70188) in the "dsPIC33F/PIC24H Family Reference Manual" for information on enabling the UART module for receive or transmit operation.

2: This feature is only available for the 16x BRG mode (BRGH = 0).

#### REGISTER 19-14: CIBUFPNT3: ECAN™ MODULE FILTER 8-11 BUFFER POINTER REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
	F11BP	<3:0>		F10BP<3:0>				
bit 15							bit 8	

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
F9BP<3:0>				F8BP<3:0>				
bit 7							bit 0	

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-12 F11BP<3:0>: RX Buffer Written when Filter 11 Hits bits

1111 = Filter hits received in RX FIFO buffer 1110 = Filter hits received in RX Buffer 14

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0001 = Filter hits received in RX Buffer 1 0000 = Filter hits received in RX Buffer 0

bit 11-8 F10BP<3:0>: RX Buffer Written when Filter 10 Hits bits

1111 = Filter hits received in RX FIFO buffer 1110 = Filter hits received in RX Buffer 14

•

•

•

0001 = Filter hits received in RX Buffer 1 0000 = Filter hits received in RX Buffer 0

bit 7-4 F9BP<3:0>: RX Buffer Written when Filter 9 Hits bits

1111 = Filter hits received in RX FIFO buffer 1110 = Filter hits received in RX Buffer 14

•

.

0001 = Filter hits received in RX Buffer 1 0000 = Filter hits received in RX Buffer 0

bit 3-0 **F8BP<3:0>:** RX Buffer Written when Filter 8 Hits bits

1111 = Filter hits received in RX FIFO buffer 1110 = Filter hits received in RX Buffer 14

•

•

•

0001 = Filter hits received in RX Buffer 1 0000 = Filter hits received in RX Buffer 0

#### REGISTER 20-2: ADxCON2: ADCx CONTROL REGISTER 2 (where x = 1 or 2)

R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0
VCFG<2:0>		_	_	CSCNA	CHPS	<1:0>	
bit 15							bit 8

R-0		U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
BUF	S	_		SMP	BUFM	ALTS		
bit 7								bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

#### bit 15-13 VCFG<2:0>: Converter Voltage Reference Configuration bits

	VREF+	VREF-		
000	AVDD	AVss		
001	External VREF+	AVss		
010	AVDD	External VREF-		
011	External VREF+	External VREF-		
1xx	AVDD	AVss		

bit 12-11 **Unimplemented:** Read as '0'

bit 10 CSCNA: Scan Input Selections for CH0+ during Sample A bit

1 = Scan inputs

0 = Do not scan inputs

bit 9-8 CHPS<1:0>: Selects Channels Utilized bits

When AD12B = 1, CHPS<1:0> is: U-0, Unimplemented, Read as '0'

1x = Converts CH0, CH1, CH2 and CH3

01 = Converts CH0 and CH1

00 = Converts CH0

bit 7 **BUFS:** Buffer Fill Status bit (only valid when BUFM = 1)

1 = ADC is currently filling second half of buffer, user should access data in first half 0 = ADC is currently filling first half of buffer, user should access data in second half

bit 6 Unimplemented: Read as '0'

bit 5-2 **SMPI<3:0>:** Selects Increment Rate for DMA Addresses bits or number of sample/conversion operations per interrupt

1111 = Increments the DMA address or generates interrupt after completion of every 16th sample/conversion operation

1110 = Increments the DMA address or generates interrupt after completion of every 15th sample/conversion operation

•

0001 = Increments the DMA address or generates interrupt after completion of every 2nd sample/conversion operation

0000 = Increments the DMA address or generates interrupt after completion of every sample/conversion operation

bit 1 **BUFM:** Buffer Fill Mode Select bit

1 = Starts filling first half of buffer on first interrupt and second half of buffer on next interrupt

0 = Always starts filling buffer from the beginning

bit 0 ALTS: Alternate Input Sample Mode Select bit

1 = Uses channel input selects for Sample A on first sample and Sample B on next sample

0 = Always uses channel input selects for Sample A

#### REGISTER 20-3: ADxCON3: ADCx CONTROL REGISTER 3

R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ADRC	_	_			SAMC<4:0>(1)		
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
ADCS<7:0>(2)								
bit 7							bit 0	

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

```
bit 15
                ADRC: ADC Conversion Clock Source bit
                1 = ADC internal RC clock
                0 = Clock derived from system clock
bit 14-13
                Unimplemented: Read as '0'
                SAMC<4:0>: Auto Sample Time bits<sup>(1)</sup>
bit 12-8
                11111 = 31 TAD
                00001 = 1 TAD
                00000 = 0 TAD
bit 7-0
                ADCS<7:0>: Analog-to-Digital Conversion Clock Select bits(2)
                11111111 = Reserved
                01000000 = Reserved
                001111111 = Tcy \cdot (ADCS<7:0> + 1) = 64 \cdot Tcy = TAD
                00000010 = Tcy \cdot (ADCS < 7:0 > + 1) = 3 \cdot Tcy = Tad
                00000001 = Tcy \cdot (ADCS < 7:0 > + 1) = 2 \cdot Tcy = Tad
                000000000 = Tcy \cdot (ADCS < 7:0 > + 1) = 1 \cdot Tcy = Tad
```

Note 1: This bit only used if ADxCON1<7:5> (SSRC<2:0>) = 111.2: This bit is not used if ADxCON3<15> (ADRC) = 1.

### REGISTER 20-9: AD1PCFGH: ADC1 PORT CONFIGURATION REGISTER HIGH<sup>(1,2,3,4)</sup>

| R/W-0  |
|--------|--------|--------|--------|--------|--------|--------|--------|
| PCFG31 | PCFG30 | PCFG29 | PCFG28 | PCFG27 | PCFG26 | PCFG25 | PCFG24 |
| bit 15 |        |        |        |        |        |        | bit 8  |

| R/W-0  |
|--------|--------|--------|--------|--------|--------|--------|--------|
| PCFG23 | PCFG22 | PCFG21 | PCFG20 | PCFG19 | PCFG18 | PCFG17 | PCFG16 |
| bit 7  |        |        |        |        |        |        | bit 0  |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-0 **PCFG<31:16>:** ADC Port Configuration Control bits

- 1 = Port pin in Digital mode, port read input enabled, ADC input multiplexer connected to AVss
- 0 = Port pin in Analog mode, port read input disabled, ADC samples pin voltage
- **Note 1:** On devices without 32 analog inputs, all PCFG bits are R/W by user. However, PCFG bits are ignored on ports without a corresponding input on device.
  - 2: ADC2 only supports analog inputs AN0-AN15; therefore, no ADC2 high port Configuration register exists.
  - 3: PCFGx = ANx, where x = 16 through 31.
  - **4:** PCFGx bits will have no effect if ADC module is disabled by setting ADxMD bit in the PMDx register. In this case all port pins multiplexed with ANx will be in Digital mode.

### TABLE 22-2: INSTRUCTION SET OVERVIEW (CONTINUED)

Base Instr #	Assembly Mnemonic		Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
66	TBLRDL	TBLRDL	Ws,Wd	Read Prog<15:0> to Wd	1	2	None
67	TBLWTH	TBLWTH	Ws,Wd	Write Ws<7:0> to Prog<23:16>	1	2	None
68	TBLWTL	TBLWTL	Ws,Wd	Write Ws to Prog<15:0>	1	2	None
69	ULNK	ULNK		Unlink Frame Pointer	1	1	None
70	XOR	XOR	f	f = f .XOR. WREG	1	1	N,Z
		XOR	f,WREG	WREG = f .XOR. WREG	1	1	N,Z
		XOR	#lit10,Wn	Wd = lit10 .XOR. Wd	1	1	N,Z
		XOR	Wb,Ws,Wd	Wd = Wb .XOR. Ws	1	1	N,Z
		XOR	Wb,#lit5,Wd	Wd = Wb .XOR. lit5	1	1	N,Z
71	ZE	ZE	Ws, Wnd	Wnd = Zero-extend Ws	1	1	C,Z,N

#### 24.0 ELECTRICAL CHARACTERISTICS

This section provides an overview of PIC24HJXXXGPX06A/X08A/X10A electrical characteristics. Additional information is provided in future revisions of this document as it becomes available.

Absolute maximum ratings for the PIC24HJXXXGPX06A/X08A/X10A family are listed below. Exposure to these maximum rating conditions for extended periods can affect device reliability. Functional operation of the device at these or any other conditions above the parameters indicated in the operation listings of this specification is not implied.

### **Absolute Maximum Ratings**

### (See Note 1)

Ambient temperature under bias	40°C to +125°C
Storage temperature	65°C to +160°C
Voltage on VDD with respect to Vss	
Voltage on any pin that is not 5V tolerant with respect to Vss <sup>(4)</sup>	0.3V to (VDD + 0.3V)
Voltage on any 5V tolerant pin with respect to Vss when VDD ≥ 3.0V <sup>(4)</sup>	0.3V to +5.6V
Voltage on any 5V tolerant pin with respect to Vss when VDD < 3.0V <sup>(4)</sup>	0.3V to 3.6V
Maximum current out of Vss pin	300 mA
Maximum current into VDD pin <sup>(2)</sup>	250 mA
Maximum current sourced/sunk by any 2x I/O pin(3)	8 mA
Maximum current sourced/sunk by any 4x I/O pin <sup>(3)</sup>	15 mA
Maximum current sourced/sunk by any 8x I/O pin <sup>(3)</sup>	25 mA
Maximum current sunk by all ports	200 mA
Maximum current sourced by all ports <sup>(2)</sup>	200 mA

- **Note 1:** Stresses above those listed under "Absolute Maximum Ratings" can cause permanent damage to the device. This is a stress rating only, and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods can affect device reliability.
  - 2: Maximum allowable current is a function of device maximum power dissipation (see Table 24-2).
  - **3:** Exceptions are CLKOUT, which is able to sink/source 25 mA, and the VREF+, VREF-, SCLx, SDAx, PGECx and PGEDx pins, which are able to sink/source 12 mA.
  - 4: See the "Pin Diagrams" section for 5V tolerant pins.

### TABLE 24-17: PLL CLOCK TIMING SPECIFICATIONS (VDD = 3.0V TO 3.6V)

AC CHA	RACTERI	STICS	Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for Extended					
Param No.	Symbol	Characteristic		Min	Typ <sup>(1)</sup>	Max	Units	Conditions
OS50	FPLLI	PLL Voltage Controlled Oscillator (VCO) Input Frequency Range <sup>(2)</sup>		0.8	_	8	MHz	ECPLL, HSPLL, XTPLL modes
OS51	Fsys	On-Chip VCO System Frequency		100	_	200	MHz	_
OS52	TLOCK	PLL Start-up Time (Lock Time)		0.9	1.5	3.1	mS	_
OS53	DCLK	CLKO Stability (Jitter)		-3	0.5	3	%	Measured over 100 ms period

- **Note 1:** Data in "Typ" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.
  - 2: These parameters are characterized by similarity but are not tested in manufacturing. This specification is based on clock cycle by clock cycle measurements. To calculate the effective jitter for individual time base or communication clocks used by peripherals use the formula:

Peripheral Clock Jitter = DCLK / √(Fosc/Peripheral bit rate clock)

Example Only: Fosc = 80 MHz, DCLK = 3%, SPI bit rate clock, (i.e. SCK), is 5 MHz

SPI SCK Jitter = [ DCLK /  $\sqrt{(80 \text{ MHz}/5 \text{ MHz})}$ ] = [3%/ $\sqrt{16}$ ] = [3% / 4] = 0.75%

#### TABLE 24-18: AC CHARACTERISTICS: INTERNAL FRC ACCURACY

AC CHARACTERISTICS		Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for Extended							
Param No.	Characteristic	Min	Тур	Max	Units	Conditions			
	Internal FRC Accuracy @ 7.3728 MHz <sup>(1)</sup>								
F20a	FRC	-2	_	+2	%	$-40^{\circ}\text{C} \le \text{Ta} \le +85^{\circ}\text{C}$	VDD = 3.0-3.6V		
F20b	FRC	-5	_	+5	%	-40°C ≤ TA ≤ +125°C	VDD = 3.0-3.6V		

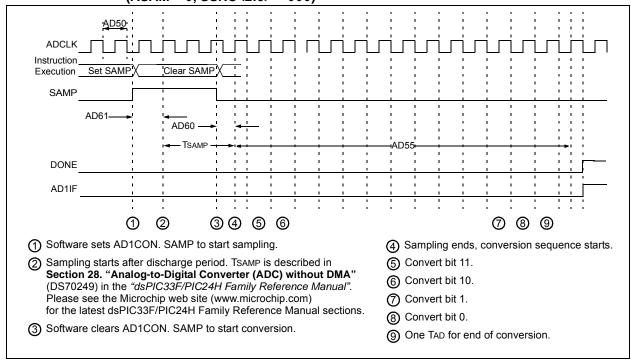
Note 1: Frequency calibrated at 25°C and 3.3V. TUN bits can be used to compensate for temperature drift.

### **TABLE 24-19: INTERNAL LPRC ACCURACY**

AC CHARACTERISTICS		Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for Extended							
Param No.	Characteristic	Min	Тур	Max	Units	Conditions			
	LPRC @ 32.768 kHz <sup>(1)</sup>								
F21a	LPRC	-30	_	+30	%	-40°C ≤ TA ≤ +85°C	_		
F21b	LPRC	-35	_	+35	%	-40°C ≤ TA ≤ +125°C	_		

Note 1: Change of LPRC frequency as VDD changes.

FIGURE 24-22: ADC CONVERSION (12-BIT MODE) TIMING CHARACTERISTICS (ASAM = 0, SSRC<2:0> = 000)



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